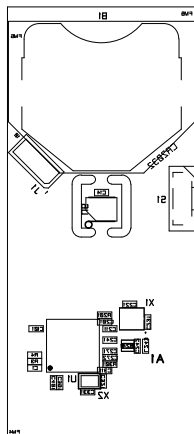



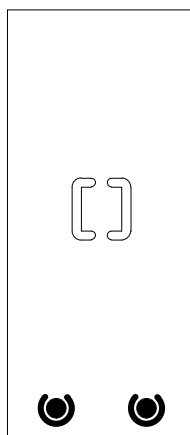
ASSEMBLY DRAWING PRIMARY SIDE
VIEWED FROM PRIMARY SIDE

PROJECTION		SCALE		TEXAS INSTRUMENTS	
DATE 21. NOV 2012		1:1		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag	
DRAWN ESS					
DESIGN					
CHECK					
APPROVED					
SIZE		DOC.NO.			REV.
CMnr :					SHEET 3 OF 15




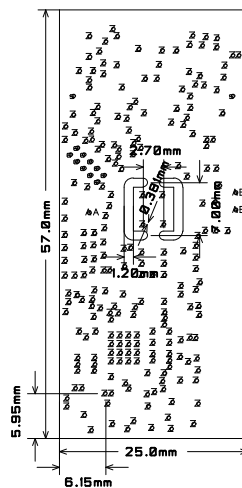
ASSEMBLY DRAWING SECONDARY SIDE
VIEWED FROM PRIMARY SIDE

PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag		
DRAWN ESS				
DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
Cmnr :				SHEET 14 OF 15



CARBON PASTE PRIMARY SIDE
VIEWED FROM PRIMARY SIDE

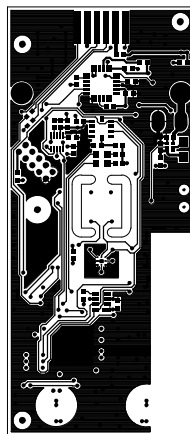
PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag		
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DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
CMnr :			SHEET	15 OF 15




DRILL DRAWING
VIEWED FROM PRIMARY SIDE

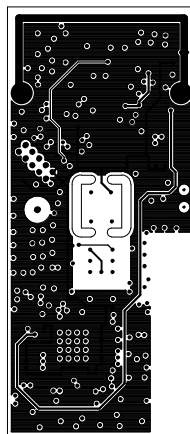
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		1:1			
DATE		21. NOV 2012			
DRAWN		ESS			
DESIGN		DRAWING TITLE			
CHECK					
APPROVED					
SIZE		DOC.NO.			REV.
CMnr :					SHEET 1 OF 15

MASTER DRAWING
CC2541Sensor Tag




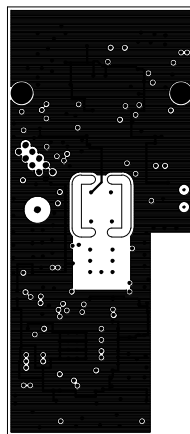
PRIMARY SIDE (LAYER 1)
VIEWED FROM PRIMARY SIDE

PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag		
DRAWN ESS				
DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
Cmnr :				SHEET 7 OF 15




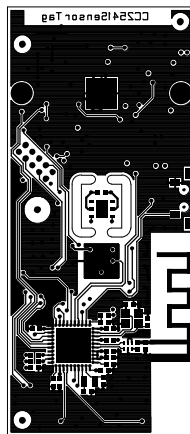
LAYER 2
VIEWED FROM PRIMARY SIDE

PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag		
DRAWN ESS				
DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
Cmnr :			SHEET	8 OF 15




LAYER 3
VIEWED FROM PRIMARY SIDE

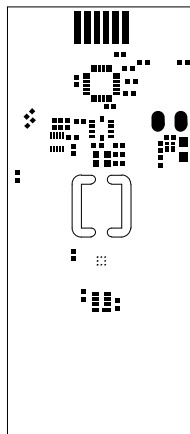
PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag		
DRAWN ESS				
DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
Cmnr :			SHEET	9 OF 15




SECONDARY SIDE (LAYER 4)
VIEWED FROM PRIMARY SIDE

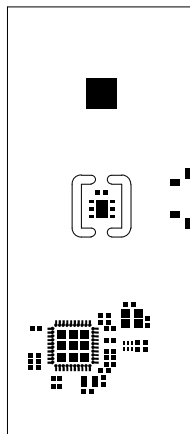
PROJECTION		SCALE		TEXAS INSTRUMENTS	
		1:1			
DATE		21. NOV 2012			
DRAWN		ESS			
DESIGN		DRAWING TITLE			
CHECK					
APPROVED					
SIZE		DOC.NO.		REV.	
Cmnr :				SHEET 10 OF 15	

MASTER DRAWING
CC2541Sensor Tag




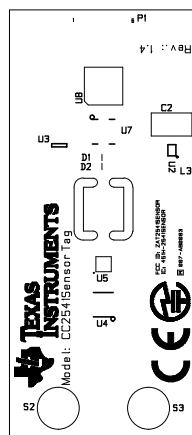
SOLDER PASTE PRIMARY SIDE
VIEWED FROM PRIMARY SIDE

PROJECTION				SCALE	TEXAS INSTRUMENTS	
DATE		21. NOV 2012		1:1		
DRAWN		ESS		DRAWING TITLE		
DESIGN				MASTER DRAWING		
CHECK				CC2541Sensor Tag		
APPROVED						
SIZE		DOC.NO.				REV.
CMnr :				SHEET		4 OF 15




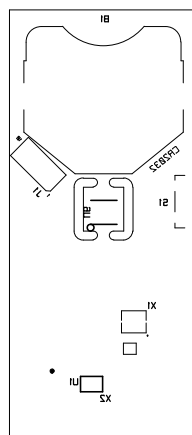
SOLDER PASTE SECONDARY SIDE
VIEWED FROM PRIMARY SIDE

PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag		
DRAWN ESS				
DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
Cmnr :				SHEET 13 OF 15




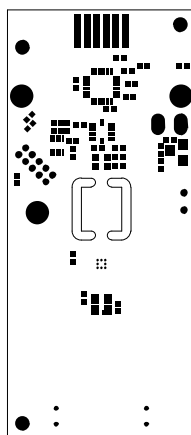
SILK SCREEN PRIMARY SIDE
VIEWED FROM PRIMARY SIDE

PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541 Sensor Tag		
DRAWN ESS				
DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
CMnr :			SHEET	5 OF 15




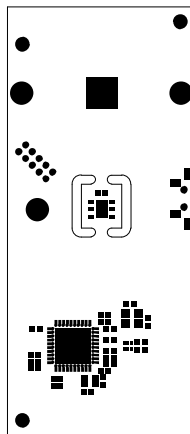
SILK SCREEN SECONDARY SIDE
VIEWED FROM PRIMARY SIDE

PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag		
DRAWN ESS				
DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
CMnr :			SHEET 12 OF 15	




SOLDER RESIST PRIMARY SIDE
VIEWED FROM PRIMARY SIDE

PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag		
DRAWN ESS				
DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
CMnr :			SHEET	6 OF 15



SOLDER RESIST SECONDARY SIDE
VIEWED FROM PRIMARY SIDE

PROJECTION 		SCALE 1:1	TEXAS INSTRUMENTS	
DATE 21. NOV 2012		DRAWING TITLE MASTER DRAWING CC2541Sensor Tag		
DRAWN ESS				
DESIGN				
CHECK				
APPROVED				
SIZE		DOC.NO.		REV.
CMnr :				SHEET 11 OF 15

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